SPECTRUM ==

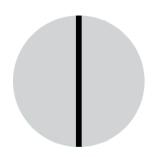


Quality Product | Quality People | Quality Service



Types of Diamond Cutting Process

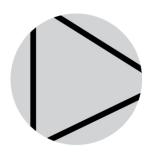




Pie Sawing



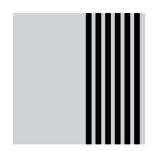
Multi Sawing



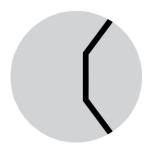
Polki Sawing



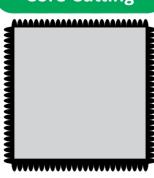
Slice Cut



C Cut Sawing



Core Cutting







SPECIAL FEATURES

- Low Weightloss.
- Multitop Cutting in Only One Set-up.
- Next to "Nil" Breakage ratio.
- Smooth Cutting Surface.
- Easy and smart Program.
- High Production.
- Auto Image Capture.
- Advanced Software Feature.

Technical specification

LASER

Wavelength : 532 nm
Output Power @ 7.5 KHz, Watts : 16 W
Transverse Mode : TEMoo
Beam Diameter, mm : 0.6
Beam Quality (M2) : < 1.2

Pulse repetition frequecy (PRF), KHz : 1-20
Pulse width @ 7-10 KHz, ns : 70
Pulse Stability @ 10 KHz (RMS) : 3

Polarozation : Liner (Vertical)

Output Stability (% Over 8 hrs) : 1

Working Temp© : 25

CNC SYSTEM

Axis Travel : 135 mm* 135mm* 75 mm

Resolution : 1 Micron or better Accuracy : 2 Micron/25 mm

Repeatability : 2 Micron/25 mm bi directional

Drive : Servo Drive with Encoder.

MECHANICAL

Dimensions: 1270 mm* 615 mm* 1480 mm

ELECTRICAL REQUIREMENT

AC 208-230 V, 60 Hz, 8-10 Amps.

CHILLER

No Requirement of External Chiller.





" We Don't Sell, Just Help You to Buy Right Product "



Head Office:

Mr. Manish Sukhadiya

Greenwave Technologies

Office: C.S. No. 909/B, F.P. No. 20/B,

Opp. C.K. Park Soc, A.K. Road,

Surat-395008, (Guj) INDIA.

Web: www.greenwave.org.in

Email:sales@greenwave.org.in | info@greenwave.org.in



MAKE IN INDIA

For More Detail Contact:

+91 94090 90109